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Sheet 2 of 2

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|------------------------|---------------------------|
| Application Number | 10/666,742 |
| Filing Date | September 19, 2003 |
| First Named Inventor | Wood et al. |
| Group Art Unit | Unknown |
| Examiner Name | Unknown |
| Attorney Docket Number | 60951US (03-0593 00/1 US) |

OTHER PRIOR ART -- NON PATENT LITERATURE DOCUMENTS

| Examiner Initials * | Cite No. ¹ | Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published. | T ² |
|------------------------|--------------------------|---|----------------|
| AC | | U.S. Patent Application Publication No. 2002/0171177 A1 to Kritchman et al., dated November 21, 2002 | |
| | | U.S. Patent Application Publication No. 2003/0151167 A1 to Kritchman et al., dated August 14, 2003 | |
| | | U. S. Patent Application Publication No. 2003/0176021 A1 to Grigg, dated September 18, 2003 | |
| | | MILLER et al., "Maskless Mesoscale Materials Deposition", Deposition Technology, September 2001, pages 20-22 | |
| | | MILLER, "New Laser-Directed Deposition Technology", Microelectronic Fabrication, August 2001, page 16 | |
| | | Webpage, Objet Prototyping the Future, Objet FullCure700 Series, 1 page | |
| | | Webpage, Objet Prototyping the Future, How it Works, 2 pages | |
| | | U.S. Patent Application No. 09/512,203, filed February 24, 2000, entitled "Tape Stiffener, Semiconductor Device Component Assemblies Including Same, and Stereolithographic Methods for Fabricating Same", inventor Ford B. Grigg | |
| AC | | U.S. Patent Application No. 10/666,930, filed September 19, 2003, entitled "Method and Apparatus for Supporting Wafers For Die Singulation and Subsequent Handling", inventor Farnworth et al. | |
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|-----------------------|--|--------------------|---------|
| Examiner Signature | | Date Considered | 5/17/05 |
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¹ Unique citation designation number (optional). ² Applicant is to place a check mark here if English language Translation is attached.

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